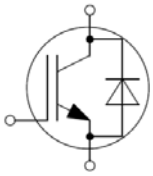
RoHS
COMPLIANT



- Inverter for motor drive
- AC and DC servo drive amplifier
- Uninterruptible power supply

- Low $V_{CE(sat)}$ Trench-FS IGBT technology
- Maximum junction temperature 175
- Positive temperature coefficient
- Including fast & soft recovery anti-parallel FWD
- High short circuit capability(10us)

Collector-Emitter Breakdown Voltage	V_{CE}	1200	V
DC Collector Current, limited by T_{jmax} T_C= 25°C T_C= 100°C	I_C	 50 25	A
Diode Forward Current, limited by T_{jmax} T_C= 25°C T_C= 100°C	I_F	 50 25	A
Continuous Gate-Emitter Voltage	V_{GE}	±20	V
Transient Gate-Emitter Voltage	V_{GE}	±30	V
Turn off Safe Operating Area V_{CE}≤1200V, T_j≤ 150°C		100	A
Pulsed Collector Current, V_{GE}=15V, tp limited by T_{jmax}	I_{CM}	100	A
Diode Pulsed Current, tp limited by T_{jmax}	IFpuls	100	A
Short Circuit Withstand Time, V_{GE}= 15V, V_{CC}=900V V_{CEM}≤1200V	T_{sc}	10	μs
Power Dissipation , Tj=175°C, Tc=25°C	P_{tot}	326	W
Operating Junction Temperature	T_j	-40...+175	°C
Storage Temperature	T_s	-55...+150	°C
Soldering Temperature, wave soldering 1.6mm (0.063in.) from case for 10s		260	°C

T_j= 25 unless otherwise specified

Collector-Emitter Breakdown Voltage	BV_{CES}	V_{GE}=0V, I_C=250μA	1200		-	V
Gate Threshold Voltage	$V_{GE(th)}$	V_{GE}=V_{CE}, I_C=0.8mA	5.1	5.8	6.4	V
Collector-Emitter Saturation Voltage	$V_{CE(sat)}$	V_{GE}=15V, I_C=25A T_j=25°C, T_j=125°C T_j=150°C		1.85 2.20 2.30	2.35	V
Zero Gate Voltage Collector Current	I_{CES}	V_{CE}=1200V, V_{GE}=0V T_j= 25°C, T_j=150°C			0.25 5.00	mA
Gate-Emitter Leakage Current	I_{GES}	V_{CE}= 0V, V_{GE}= ± 20V			100	nA

Input Capacitance	C_{ies}	V_{CE}= 25V, V_{GE}= 0V, f = 1MHz	-	1.45	-	nF
Reverse Transfer Capacitance	C_{res}		-	0.05	-	
Gate Charge	Q_G	V_{CC}=960V,I_C=25A, V_{GE}=15V	-	0.20	-	uC
Short Circuit Collector Current	I_{SC}	V_{GE}=15V, tsc≤10us, Vcc=900V,Tj≤150°C	-	110	-	A

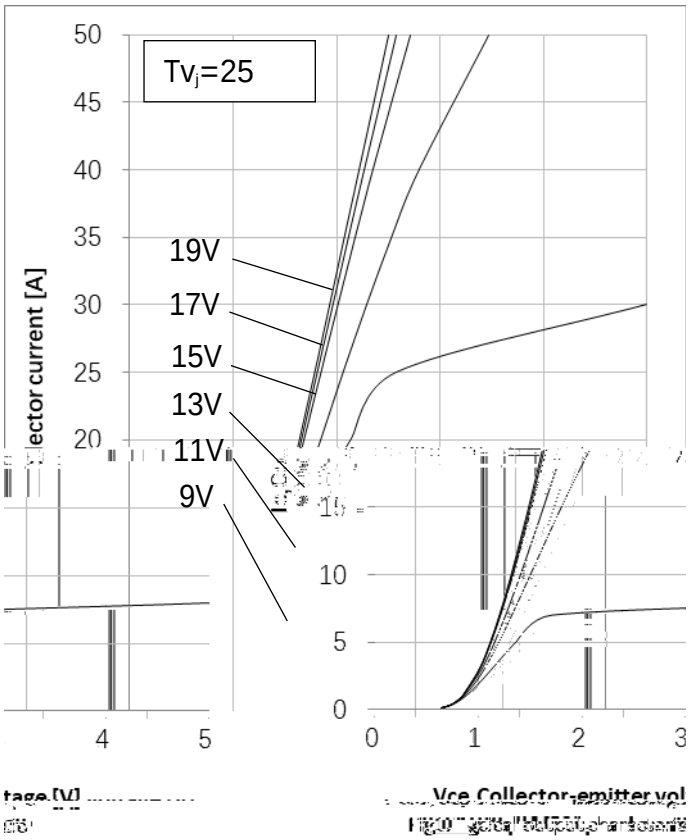
Operating Junction Temperature	T_j	-40...+175	°C
Storage Temperature	T_s	-55...+150	°C
Soldering Temperature, wave soldering 1.6mm (0.063in.) from case for 10s		260	°C

T_j= 25 unless otherwise specified

Diode Forward Voltage	V_F	I_F= 25A T_j= 25°C, T_j= 125°C T_j= 150°C		2.00 1.80 1.70		V

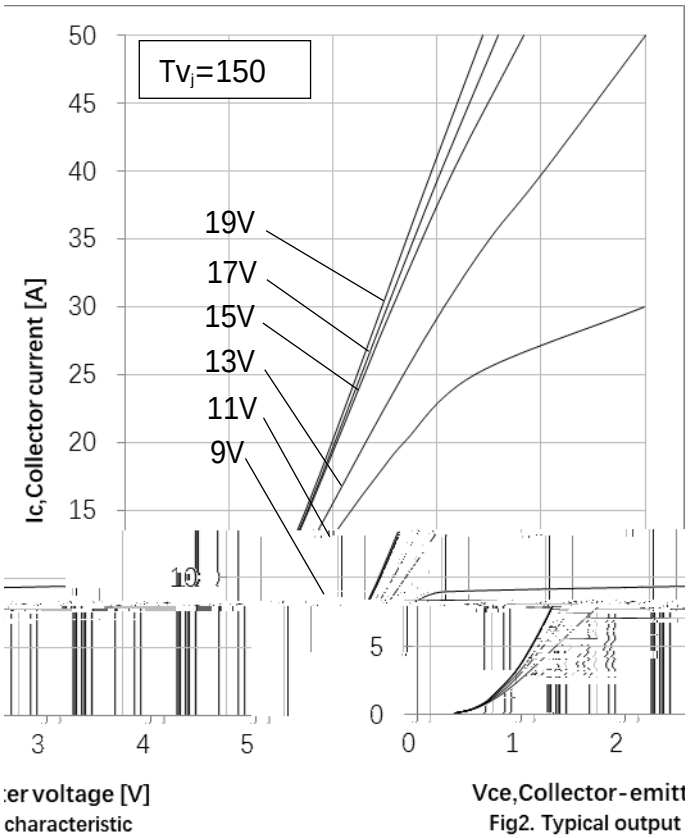
℃						
Turn-on Delay Time	t_d(on)	V_{CC}= 600V, I_C=25A, V_{GE}= -15v~15V, R_g=18Ω	-	158	-	ns
Rise Time	t_r		-	32	-	ns
Turn-on Energy	E_{on}		-	1.8	-	mJ
Turn-off Delay Time	t_d(off)		-	331	-	ns
Fall Time	t_f		-	83	-	ns
Turn-off Energy	E_{off}		-	1.4	-	mJ
℃						
Turn-on Delay Time	t_d(on)	V_{CC}= 600V, I_C=25A, V_{GE}= -15v~15V, R_g=18Ω	-	172	-	ns
Rise Time	t_r		-	45	-	ns
Turn-on Energy	E_{on}		-	2.4	-	mJ
Turn-off Delay Time	t_d(off)		-	154	-	ns
Fall Time	t_f		-	212	-	ns
Turn-off Energy	E_{off}		-	2.2	-	mJ
℃						
Turn-on Delay Time	t_d(on)	V_{CC}= 600V, I_C=25A, V_{GE}= -15v~15V, R_g=18Ω	-	190	-	ns
Rise Time	t_r		-	48	-	ns
Turn-on Energy	E_{on}		-	2.8	-	mJ
Turn-off Delay Time	t_d(off)		-	165	-	ns
Fall Time	t_f		-	230	-	ns
Turn-off Energy	E_{off}		-	2.4	-	mJ

℃						



tage [V]

Vce Collector-emitter vol



er voltage [V]

characteristic

Vce,Collector-emitt

Fig2. Typical output

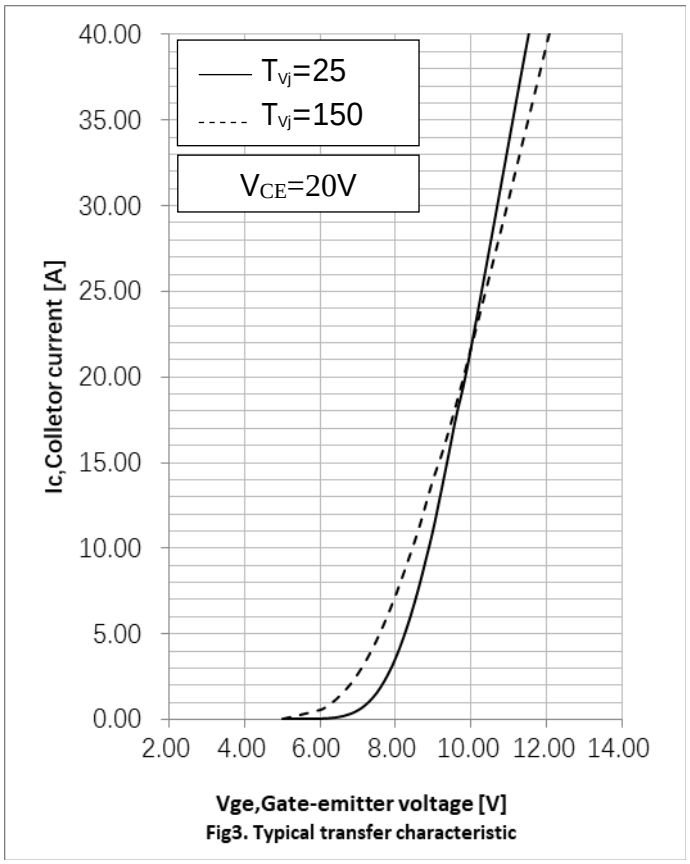


Fig3. Typical transfer characteristic

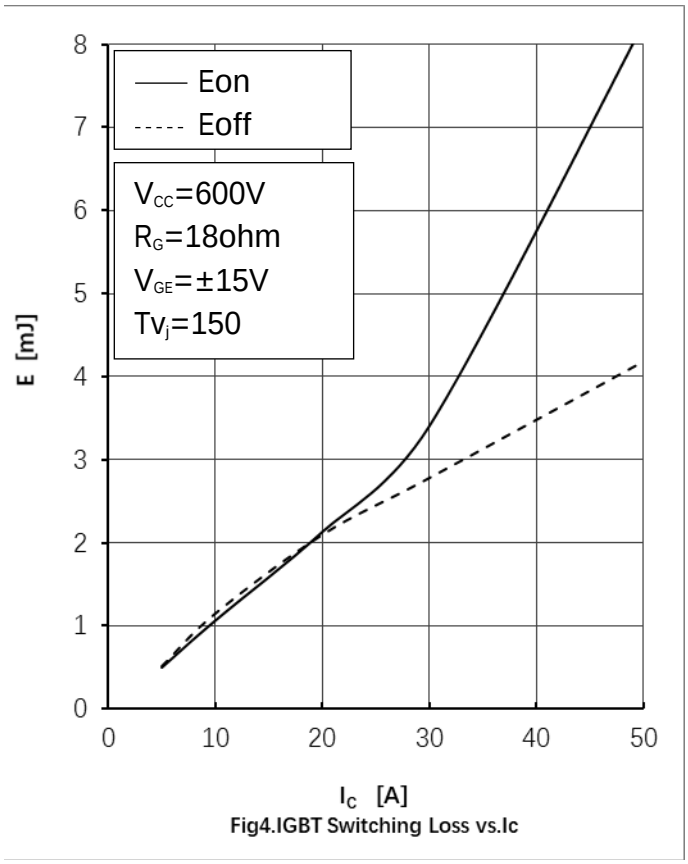


Fig4.IGBT Switching Loss vs.Ic

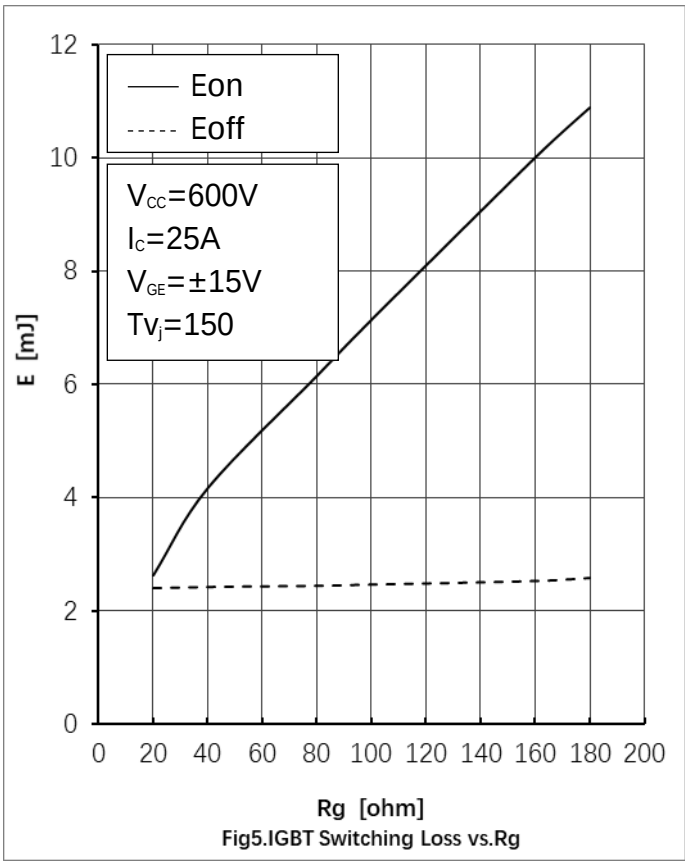


Fig5.IGBT Switching Loss vs.Rg

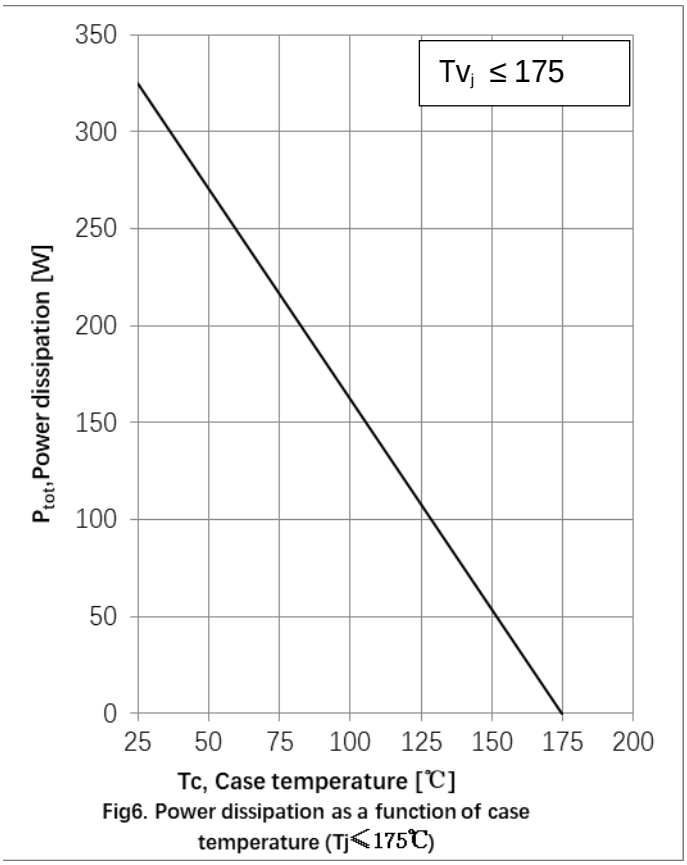


Fig6. Power dissipation as a function of case temperature (Tj≤175℃)

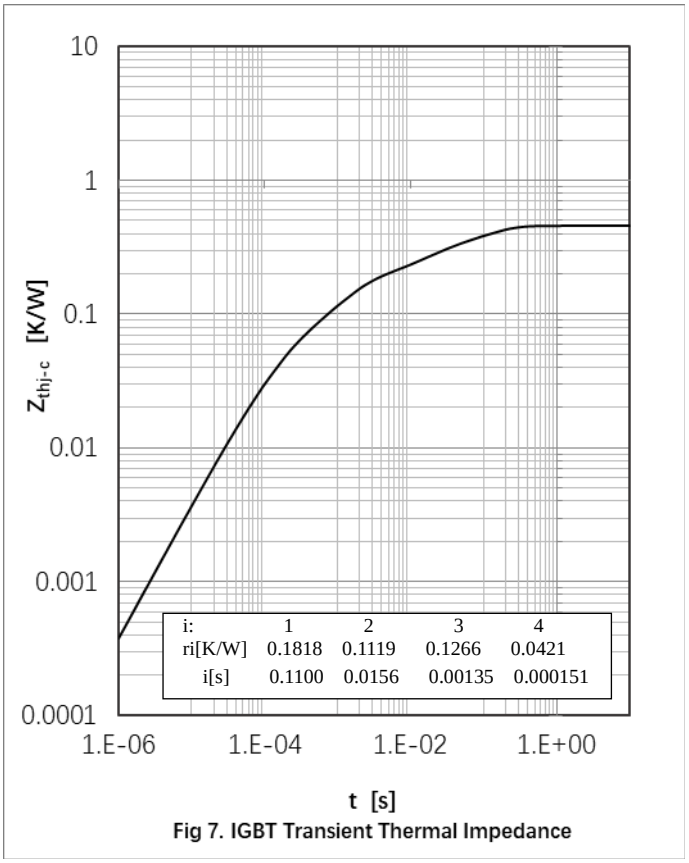
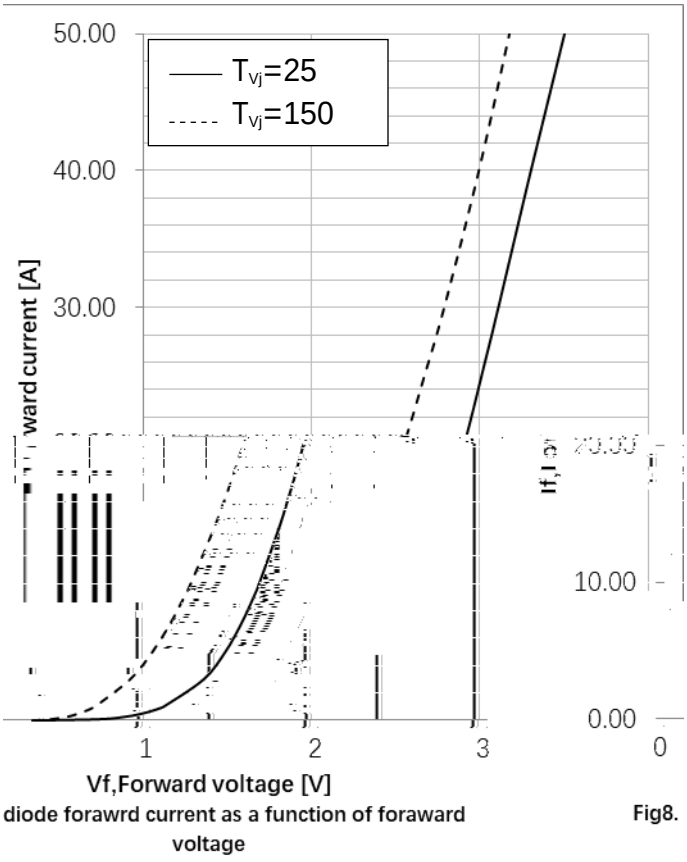


Fig 7. IGBT Transient Thermal Impedance



diode forawrd current as a function of foraward voltage

Fig8.

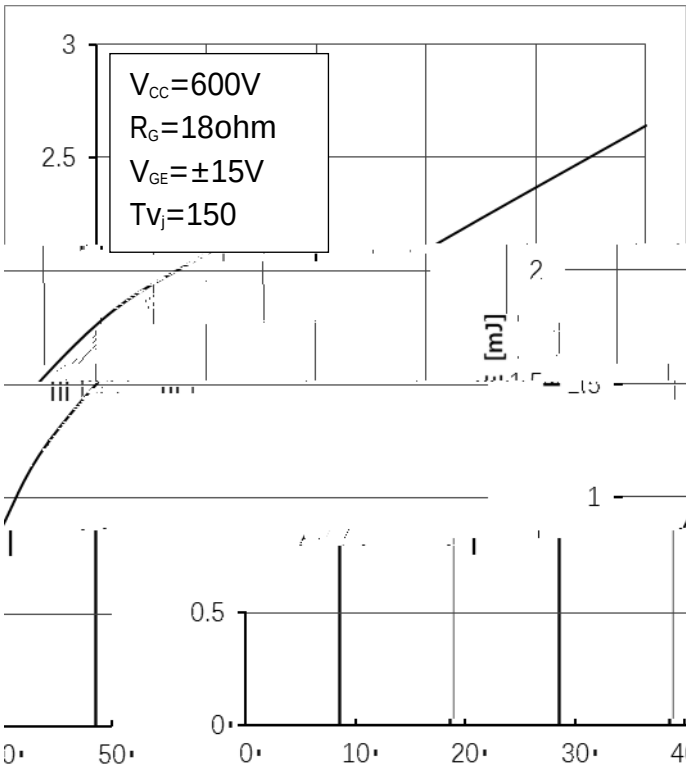
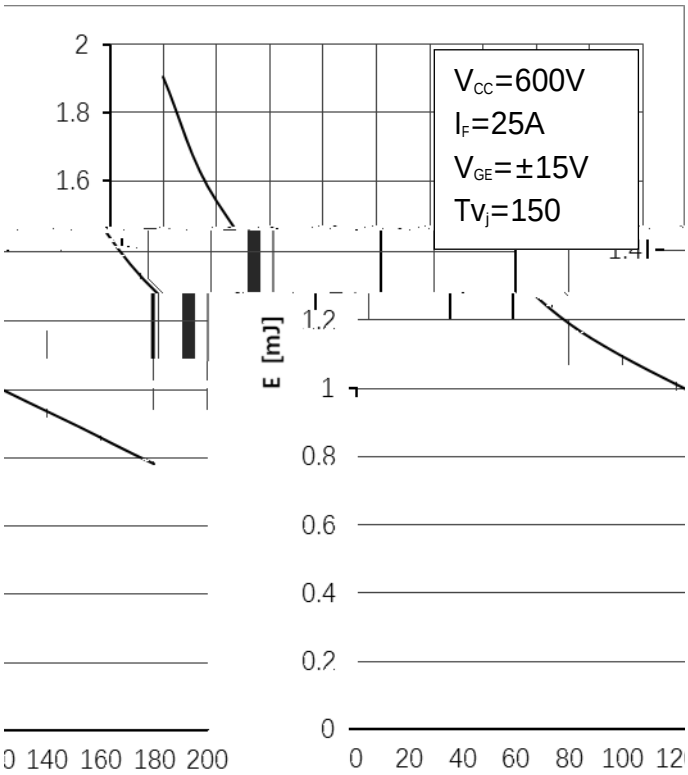


Fig9.Diode Switching Loss(Erec) vs.I_F



s(Erec) vs.Rg

Fig10.Diode Switching Los

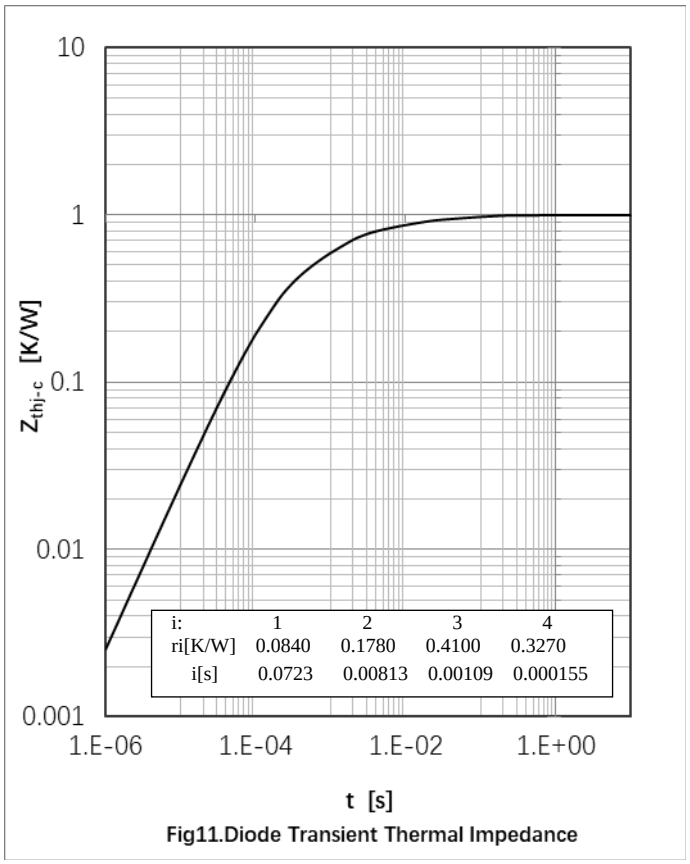
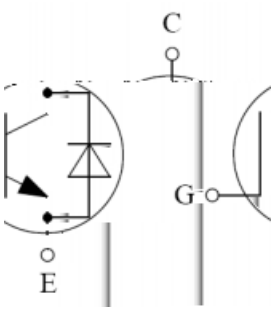
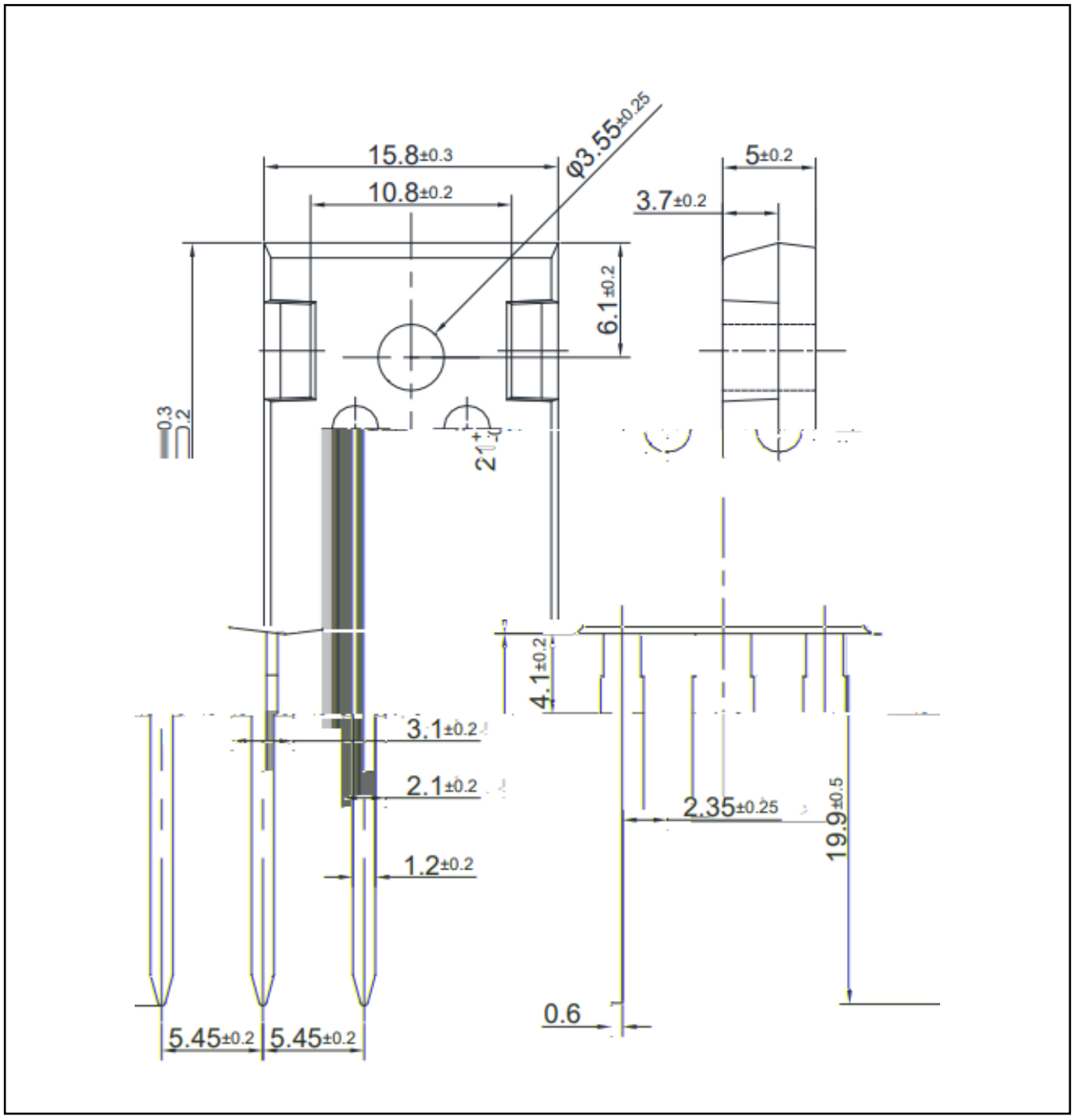


Fig11.Diode Transient Thermal Impedance


C
G
E


15.8±0.3
10.8±0.2
Φ3.55±0.25
5±0.2
3.7±0.2
6.1±0.2
3.2 0.3
21 +0.3 -0
4.1±0.2
3.1±0.2
2.1±0.2
1.2±0.2
2.35±0.25
19.9±0.5
0.6
5.45±0.2
5.45±0.2